

March 2000

Advance Information

### 1.0 Features

- Dual phase-locked loop (PLL) device with three output clock frequencies
- 3.3V supply voltage
- Small circuit board footprint (8-pin 0.150" SOIC)
- Custom frequency selections available - contact your local AMI Sales Representative for more information

### 2.0 Description

The FS6284 is a monolithic CMOS clock generator IC designed to minimize cost and component count in digital video/audio systems.

All frequencies are ratiometrically derived from the crystal oscillator frequency. The locking of all the output frequencies together can eliminate unpredictable artifacts in video systems and reduce electromagnetic interference (EMI) due to frequency harmonic stacking.

Figure 1: Pin Configuration

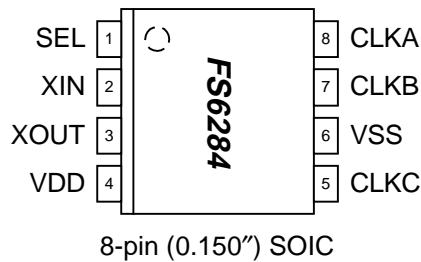
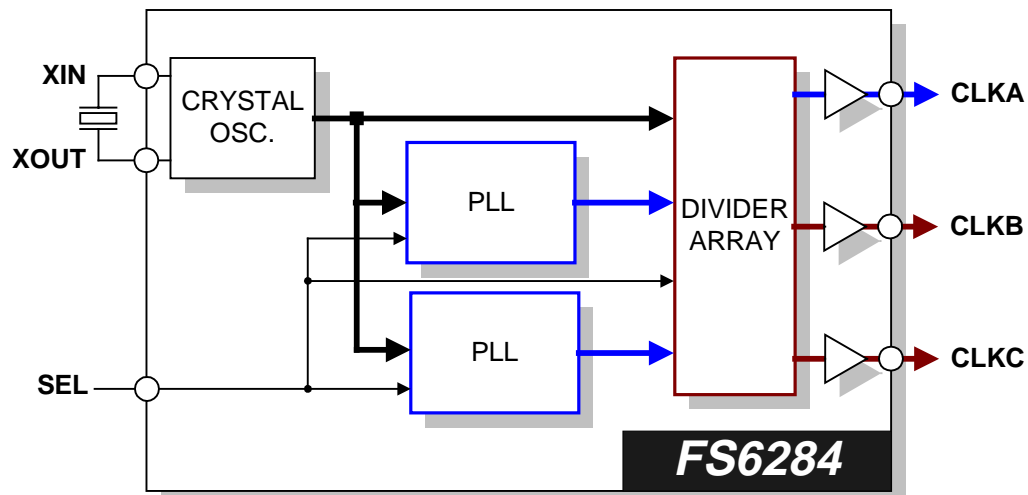


Table 1: Crystal / Output Frequencies

DEVICE	SEL	$f_{XIN}$ (MHz)	CLKA (MHz)	CLKB (MHz)	CLKC (MHz)
FS6284-01	0	14.31818	14.31818 ( $f_{XIN}$ )	48.000 ( $f_{XIN} * 352 / 105$ )	81.000 ( $f_{XIN} * 198 / 35$ )
	1				70.000 ( $f_{XIN} * 44 / 9$ )

NOTE: Contact AMI for custom PLL frequencies

Figure 2: Block Diagram



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### Table 2: Pin Descriptions

Key: AI = Analog Input; AO = Analog Output; DI = Digital Input; DI<sup>U</sup> = Input with Internal Pull-Up; DI<sub>D</sub> = Input with Internal Pull-Down; DIO = Digital Input/Output; DI-3 = Three-Level Digital Input, DO = Digital Output; P = Power/Ground; # = Active Low pin

PIN	TYPE	NAME	DESCRIPTION
1	DI <sup>U</sup>	SEL	Select Input (see Table 1)
2	AI	XIN	Crystal Oscillator Drive / External Reference Input
3	AO	XOUT	Crystal Oscillator Feedback
4	P	VDD	Power (+3.3 volts)
5	DO	CLKC	Clock Output C
6	P	VSS	Ground
7	DO	CLKB	Clock Output B
8	DO	CLKA	Clock Output A

## 3.0 Electrical Specifications

### Table 3: Absolute Maximum Ratings

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These conditions represent a stress rating only, and functional operation of the device at these or any other conditions above the operational limits noted in this specification is not implied. Exposure to maximum rating conditions for extended conditions may affect device performance, functionality, and reliability.

PARAMETER	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage ( $V_{SS}$ = ground)	$V_{DD}$	$V_{SS}-0.5$	7	V
Input Voltage, dc	$V_I$	$V_{SS}-0.5$	$V_{DD}+0.5$	V
Output Voltage, dc	$V_O$	$V_{SS}-0.5$	$V_{DD}+0.5$	V
Input Clamp Current, dc ( $V_I < 0$ or $V_I > V_{DD}$ )	$I_{IK}$	-50	50	mA
Output Clamp Current, dc ( $V_I < 0$ or $V_I > V_{DD}$ )	$I_{OK}$	-50	50	mA
Storage Temperature Range (non-condensing)	$T_S$	-65	150	°C
Ambient Temperature Range, Under Bias	$T_A$	-55	125	°C
Junction Temperature	$T_J$		125	°C
Lead Temperature (soldering, 10s)			260	°C
Input Static Discharge Voltage Protection (MIL-STD 883E, Method 3015.7)			2	kV



#### **CAUTION: ELECTROSTATIC SENSITIVE DEVICE**

Permanent damage resulting in a loss of functionality or performance may occur if this device is subjected to a high-energy electrostatic discharge.

### Table 4: Operating Conditions

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	MIN.	TYP.	MAX.	UNITS
Supply Voltage	$V_{DD}$	$3.3V \pm 10\%$	3.0	3.3	3.6	V
Ambient Operating Temperature Range	$T_A$		0		70	°C

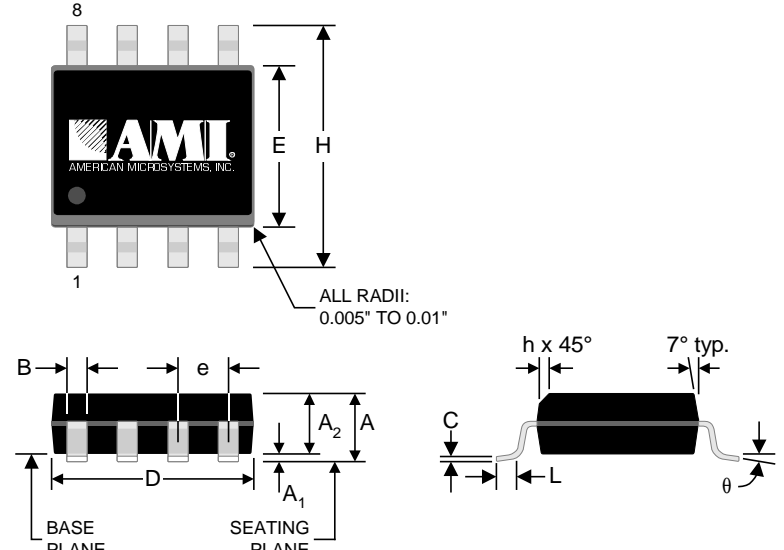
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### 4.0 Package Information

**Table 5: 8-pin SOIC (0.150") Package Dimensions**

	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	0.061	0.068	1.55	1.73
A1	0.004	0.0098	0.102	0.249
A2	0.055	0.061	1.40	1.55
B	0.013	0.019	0.33	0.49
C	0.0075	0.0098	0.191	0.249
D	0.189	0.196	4.80	4.98
E	0.150	0.157	3.81	3.99
e	0.050 BSC		1.27 BSC	
H	0.230	0.244	5.84	6.20
h	0.010	0.016	0.25	0.41
L	0.016	0.035	0.41	0.89
Θ	0°	8°	0°	8°



**Table 6: 8-pin SOIC (0.150") Package Characteristics**

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	TYP.	UNITS
Thermal Impedance, Junction to Free-Air 8-pin 0.150" SOIC	$\Theta_{JA}$	Air flow = 0 m/s	110	°C/W
Lead Inductance, Self	$L_{11}$	Corner lead	2.0	nH
		Center lead	1.6	
Lead Inductance, Mutual	$L_{12}$	Any lead to any adjacent lead	0.4	nH
Lead Capacitance, Bulk	$C_{11}$	Any lead to $V_{SS}$	0.27	pF

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## 5.0 Ordering Information

ORDERING CODE	DEVICE NUMBER	PACKAGE TYPE	OPERATING TEMPERATURE RANGE	SHIPPING CONFIGURATION
11640-xxx	FS6284-01	8-pin (0.150") SOIC (Small Outline Package)	0°C to 70°C (Commercial)	Tape and Reel
11640-xxx	FS6284-01	8-pin (0.150") SOIC (Small Outline Package)	0°C to 70°C (Commercial)	Tubes

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